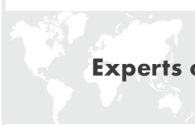


PFLOW 2008 User Manual vc.4

MEMS mass flow sensors



MEMS Mass Flow Sensors

with thermal calorimetric sensing technology

PFLOW 2008 Series

User Manual

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PFLOW2008 User Manual

 Attention!

- Please carefully read this manual before operating this product.
- Do not open or modify any hardware that may lead to irrecoverable damage.
- Do not use this product if you suspect any malfunctions or defects.
- Do not use this product for corrosive media or in a strong vibrational environment.
- Use this product according to the specified parameters.
- Only the trained or qualified personnel shall be allowed to perform product services.

 Use with caution!

- Be cautious for electrical safety, even if it operates at a low voltage; any electrical shock might lead to some unexpected damage.
- The gas to be measured should be clean and free of particles, as even light particles may be accumulated inside the tiny pressure port, which may result in inaccuracy in metrology, clogging, or other issues of irrecoverable damage.
- Do not apply for any unknown or non-specified gases that may damage the product.

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1. Overview

All contact information can be found at the end of this manual.

This manual provides essential information for the PFLOW2008 series of mass flow sensors. The products are designed for applications in automation, testing, leakage detection, instrumentation, and medical applications. The PFLOW2008 has a pure analog version with a fast response time of 1 msec, which is particularly applicable for semiconductor equipment, such as die attachment and wire bonding. The product performance, maintenance, and troubleshooting, as well as the information for product order, technical support, and repair, are also included.

The PFLOW2008 sensors are manufactured with the company's proprietary MEMS (micro-electro-mechanical systems) sensing and package technology that offers primarily the mass flow rate measurements of a full scale from 30 to 500 sccm with a dynamic range of 100:1 for PFLOW2008 and up to 6 SLPM for PFLOW2008E. Both have a maximum pressure rating of 5 bar (75 psi).

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2. Receipt / unpack of the products

Upon receipt of the products, please check the packing box before dismantling the packing materials. Ensure no damage during shipping. If any abnormality is observed, please contact and notify the carrier who shipped the product, and inform the distributors or sales representatives if the order is not placed directly with the manufacturer; otherwise, the manufacturer should be informed. For any further actions, please refer to the return and repair section in this manual.

If the packing box is intact, open it to find the product (either PFLOW2008 or PFLOW2008E, as per the actual order), along with the power and data cable if included, as shown below.



Please check immediately for the integrity of the product and the power and data cable; if any abnormality is identified, please notify the distributor/sales representative or manufacturer as soon as you can. If any defects are confirmed, an exchange shall be arranged immediately via the original sales channel. This user manual shall also be included in the packing box or via an online link for an electronic version, which your sales agent should send. In most cases, this manual shall be made available to the customer before the actual order.

3. Knowing the products

3.1 Product description

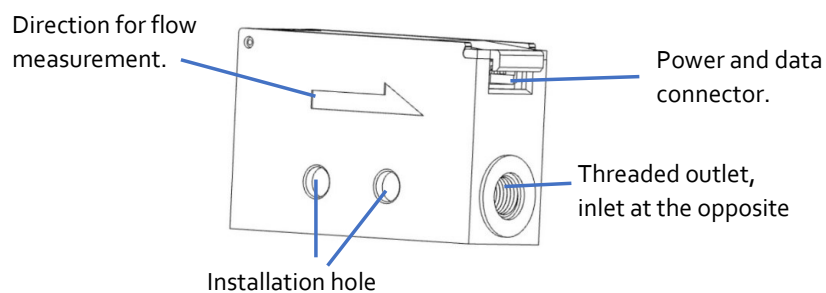


Figure 3.1: PFLOW2008 / PFLOW2008N description

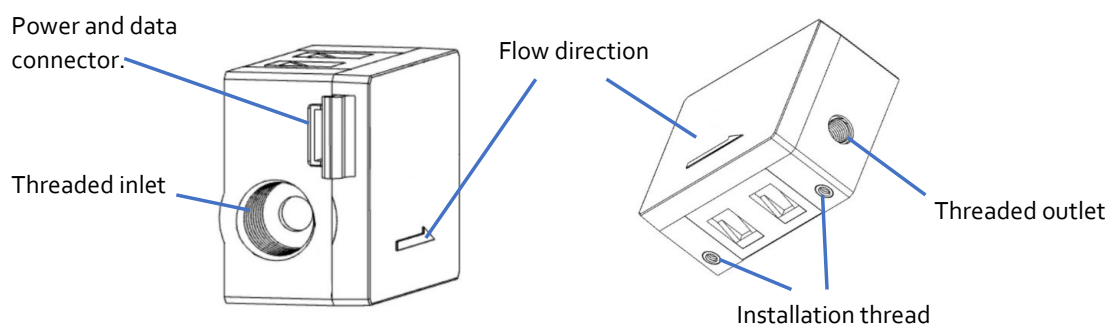


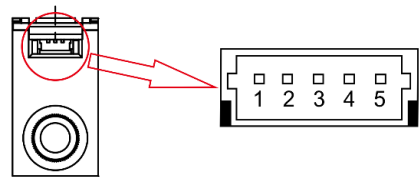
Figure 3.2: PFLOW2008E description

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3.2 Power and data pinout description

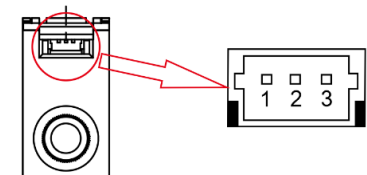
PFLOW2008 has two models: linearized and non-linear output. The non-linear output models only offer analog output with a response time of 1 msec for fast automation such as die-attachment equipment. PFLOW2008E only offers linearized models.

Table 3.1: PFLOW2008 linearized model pin assignment.



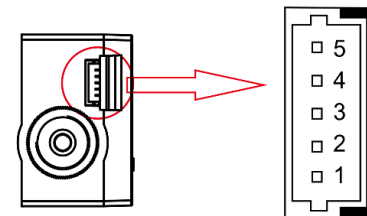
PIN	COLOR	DEFINITION
1	Yellow	SCL, I ² C clock
2	Black	GND, ground
3	Red	VCC, power supply, 8~24Vdc
4	Green	Analog output, 0.5 ~ 4.5 Vdc
5	Blue	SDA, I ² C data

Table 3.2: PFLOW2008 non-linear model (PFLOW2008N) pin assignment.



PIN	COLOR	DEFINITION
1	Brown	VCC, power supply, 8~24Vdc
2	Blue	GND, ground
3	Black	Analog output, 1 ~ 5 Vdc

Table 3.3: PFLOW2008E pin assignment.



PIN	COLOR	DEFINITION
1	Yellow	SCL, I ² C clock
2	Black	GND, ground
3	Red	VCC, power supply, 8~24Vdc
4	Green	Analog output, 0.5 ~ 4.5 Vdc
5	Blue	SDA, I ² C data

Note: The connector on the sensor is an SM05B-SRSS-TB manufactured by JST; the cable match is SHR-05V-S (no protrusions), also made by JST. The contact is either SH-003GA-Po.2 or SSH-003-Po.2H.

3.3 Mechanical dimensions

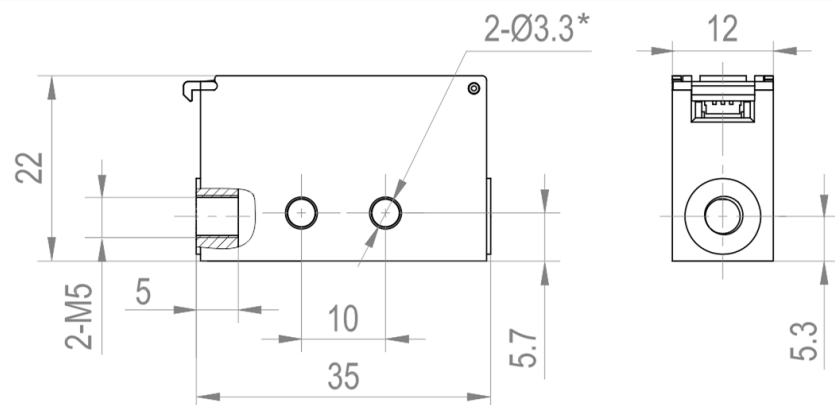


Figure 3.3: PFLOW2008 / PFLOW2008N mechanical dimensions.

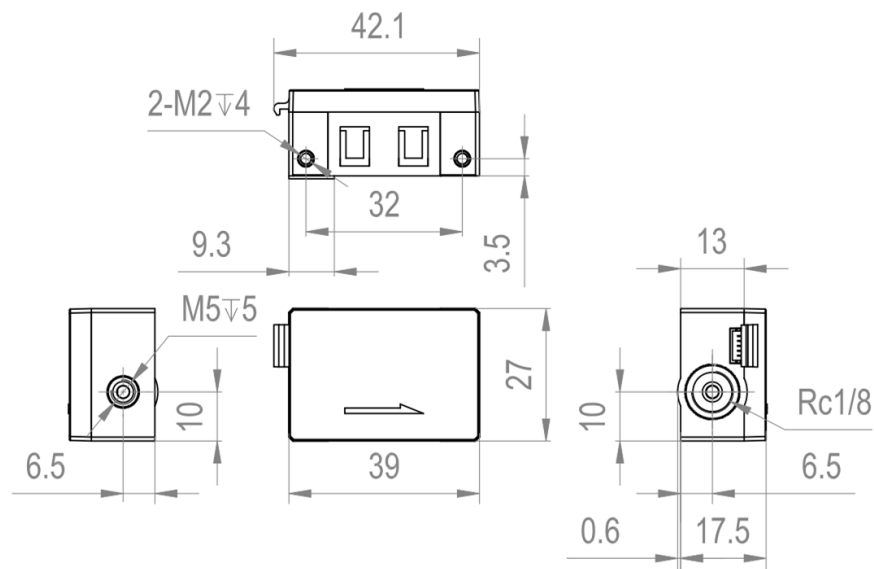


Figure 3.4: PFLOW2008E mechanical dimensions.

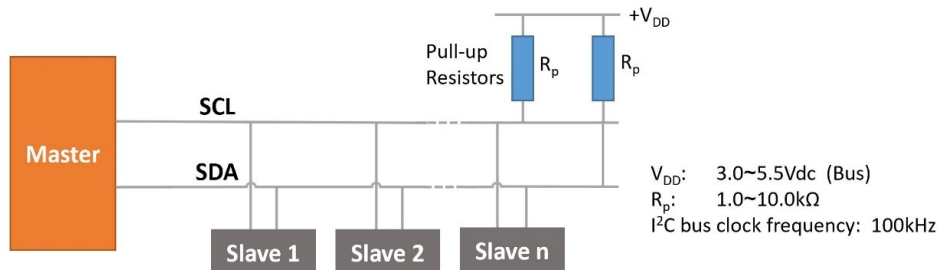
4. Installation

Do not open or alter any part of the product, which would lead to malfunction and irrecoverable damage.

For the installation, the PFLOW2008 has an installation hole fixture that can be fitted with M3 screws. Proper torque should be applied to avoid damage. The recommended torque for the M3 screw is 0.25 ± 0.03 Nm. The sensor comes with a standard data and power cable of 0.5m; users can extend the cable with a shielded counterpart. Make sure the mechanical leakage proof of the connections and all electrical precautions are applied. Please make sure the electrical pins are properly engaged. It should be noted that the sensor is designed for medium to low pressure per the applications; therefore, the system design would be necessary for the flow stability and related flow noises.

5. I²C digital communication descriptions

5.1 I²C interface connection diagram

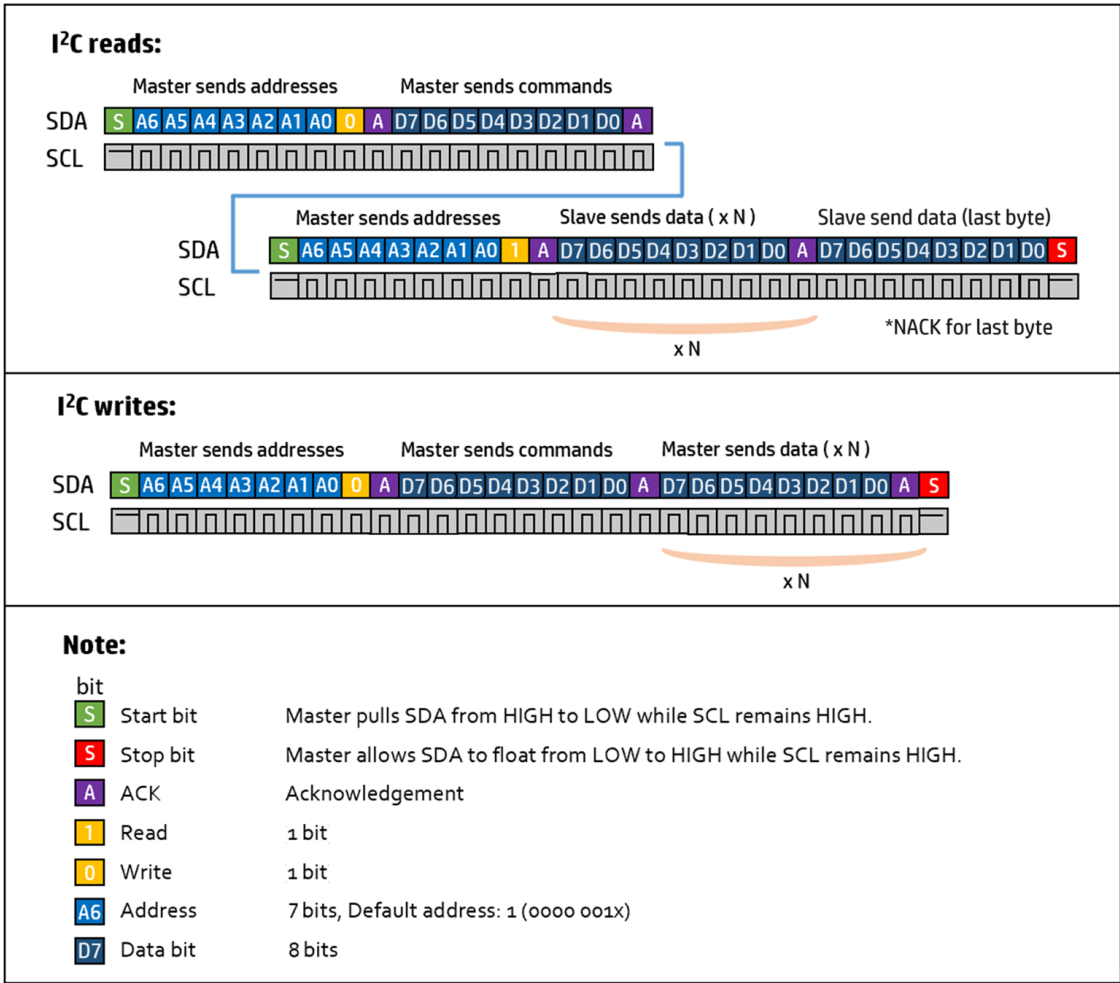


5.2 I²C interface command description

Command Byte (Hex)	Length (int 8)	Command Name	Read/Write	Notes
05H	1	I ² C address	Write	Bit 0 is the R/W flag bit; Bit 1~ Bit 7 are available.
0BH	1	Filter depth	Write	Int 8, 0~254
1CH	1	Flowrate offset reset	Write	1 byte, ensure no-flow conditions
82H	12	Serial number	Read	ASCII
83H	4	Flow rate	Read	PFLOW2008 : Int32(/1000 sccm) PFLOW2008E : Int32(/1000 SLPM)
85H	1	I ² C address	Read	Bit 7 ~ Bit 1
8BH	1	Filter depth	Read	Int 8, 0~254

Note: The I²C address is set to Bit 7~Bit 1, e.g., if the I²C address is 1 (0000 001x), the write address will be 0x02 (0000 0010) and the read address will be 0x03 (0000 0011).

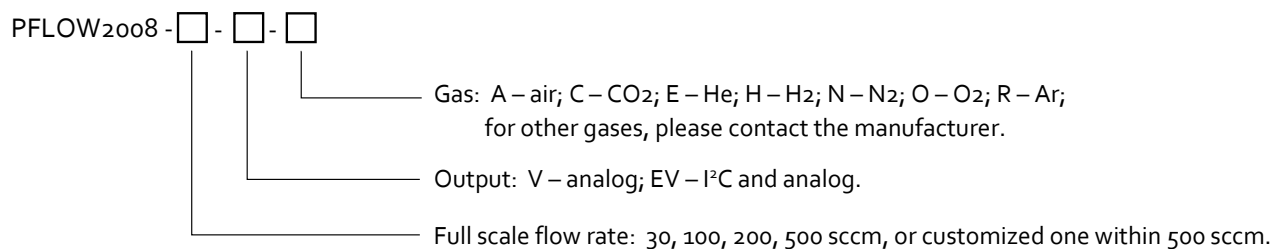
5.3 I²C interface read/write sequences



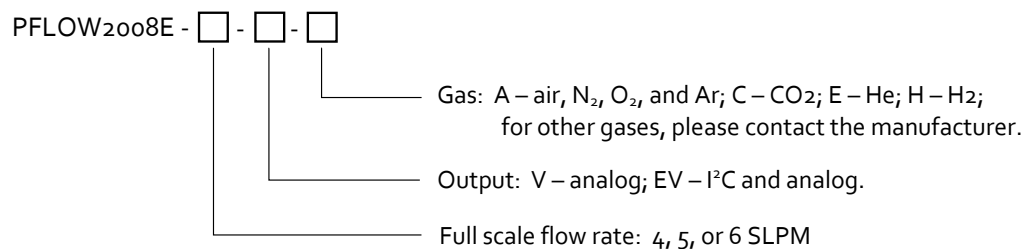
6. Product selection

The product part number is composed of the product model number and suffixes, indicating each of the selectable parameters. Refer to the following for details.

PFLOW₂₀₀₈ linear models can be selected by the following:



PFLOW_{2008E} can be selected by the following:



The PFLOW₂₀₀₈ nonlinear model does not have options; the model is named PFLOW_{2008N}.

Note: For CO₂, the maximum flow rate is 75% of the available full scale.

7. Product performance

7.1 Technical specifications

All specifications listed in the following table, unless otherwise noted, apply for standard conditions at 20°C and 101.325 kPa absolute pressure with air.

	Value	Unit
Flow range (PFLOW2008)	0 ... 30, 100, 200, 500	sccm
(PFLOW2008N)	0 ... 500	sccm
(PFLOW2008E)	0 ... 4, 5, 6	SLPM
Accuracy (total error band)	$\pm(2.0+0.5FS)$	%
Repeatability	$(0.5+0.15FS)$	%
Response time (PFLOW2008 / PFLOW2008E)	5.0	msec
(PFLOW2008N)	1.0	msec
Working temperature	0 ~ 55	°C
Temperature coefficient (PFLOW2008 / PFLOW2008N)	$<\pm 0.12$	%/°C
(PFLOW2008E)	$<\pm 0.08$	%/°C
Maximum pressure	0.5	MPa
Humidity	<95 (no condensation)	%RH
Power supply	8 ~ 24	Vdc
Working current	<20	mA
Output (PFLOW2008 / PFLOW2008E)	Linear, I ² C; Analog: 0.5~4.5Vdc	
(PFLOW2008N)	Nonlinear, Analog: 1.0 (± 0.025) ~ 5.0 (± 0.1) Vdc	
Mechanical connection (PFLOW2008 / PFLOW2008N)	M5	
(PFLOW2008E)	BSPT 1/8" (inlet); M5 (outlet)	
Maximum overflow	10x of the full scale	
Maximum flow change per second	2.5x of the full scale	
Storage temperature	-20 ~ +70	°C
Calibration	Air @ 20°C, 101.325kPa	
Compliance	RoHS	
CE	IEC 61000-2;-4	

Note: 1. Calibration with real gas is optional. Please get in touch with the manufacturer for further information.

7.2 Analog output

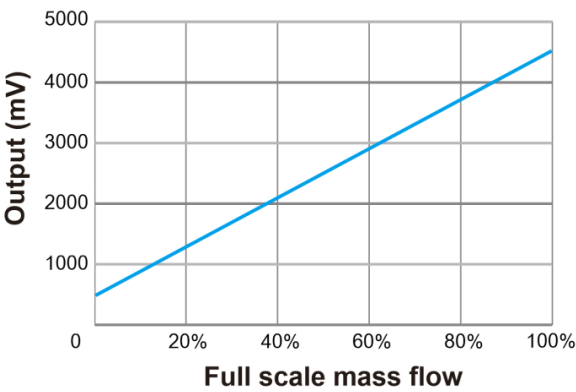


Figure 7.1: The typical analog output of the linearized models: PFLOW2008 and PFLOW2008E.

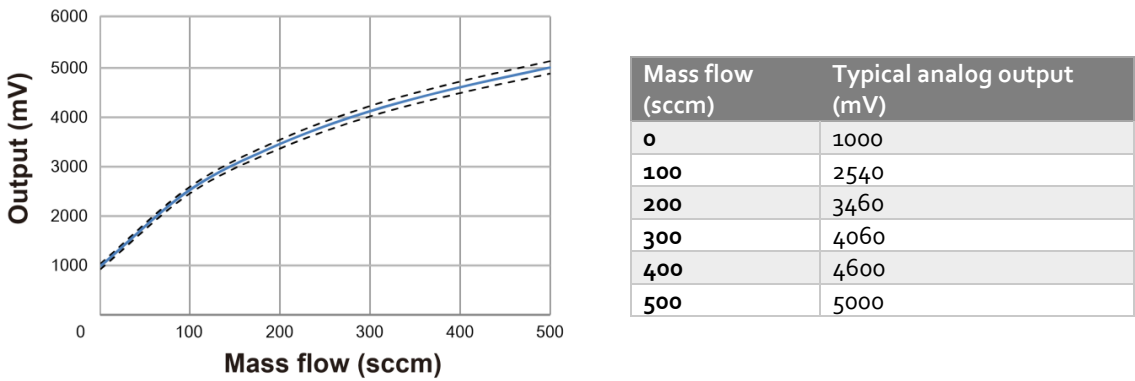


Figure 7.2: The typical analog output of the non-linearized model: PFLOW2008N.

7.3 Wetted materials

The product body is made of medical-compatible plastics (polyphenylene sulfide). The sensing element comprises silicon, silicon nitride, and silicon dioxide. The sensor chip surfaces are passivated with silicon nitride and silicon dioxide. The electronic sealing is provided by LOCTITE Ablestik 84-3J. The filter is made of 304 stainless steel. Another wetted material that may be exposed is FR-4.

8. Technical notes for the product performance

8.1 Measurement principles

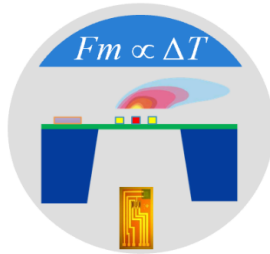


Figure 8.1: Measurement approach illustration.

The products utilize the Company's proprietary micro-machined (MEMS) calorimetric sensing and data processing technology. A thermal signal generator with a pair of sensing elements upstream and downstream of the microheater is precisely manufactured and separated at predefined micrometer distances on a chip surface with excellent thermal isolation. When a fluid is flowing through the sensing chip, the fluid carries the thermal signal downstream. The sensing elements register the temperature differences, which are then correlated with the fluid mass flow rate via the calibration process.

The calorimetric sensing approach offers an extensive dynamic range with better performance against environmental parameter alternations. Please refer to the company's US patents and other publications made available to the public for additional information.

8.2 Precautions for the best performance of the product

8.2.1 Altitude changes

Unlike some other products on the market, the design of the sensor has a built-in pressure balancer that prevents membrane deformation due to altitude changes. Therefore, the sensor is intrinsically insensitive to altitude change-induced errors. The specified altitude in Sec 7.1 has been thoroughly tested.

8.2.2 Excessive humidity or condensation

The humidity change will not alter the performance of the sensor. However, if excessive humidity is present, resulting in condensation, the measurement port or channel could be blocked or changed. This would result in a very unreliable data output. Please use other tools to prevent this situation from occurring when using this product.

8.2.3 Metrology verification

Testing the products with local metrology tools will be performed in almost all cases. It should be noted that for this particular sensor, special care should be taken while performing such a task.

The gauge pressure tests are relatively simple; as long as the pressure is tested under stable media conditions, the metrology data should be well reproduced.

For the mass flow rate comparison, however, in addition to the flow system setup conditions recommended by OIML R137, a stable flow system must be ensured. This is because the current product is designed for a slight pressure loss; therefore, the sensor lacks a strong flow restrictor or conditioners to handle the flow instability that may exist in the system. Thus, to compare the metrology data, the user should ensure the system is stable; otherwise, the output could be noisy, and metrology deviations would be inevitable. If such cases are present, please get in touch with the manufacturer for further solutions.

For temperature and humidity measurement, due to the limited space in the package, the response time for humidity measurement may be slower than specified. For additional information, please get in touch with the manufacturer.

Appendix I: Document history

Revision VC.4 (June 2026)

- Updated the flow rate length (5.2 *I²C interface command description*)

Revision VC.2.01 (August 2025)

- Corrections.

Revision VC.2 (September 2024)

- PFLOW2008P has been upgraded; the new part number is PFLOW2008E.
 - ◆ PFLOW2008E: MEMS chip change to 4th GEN MEMS chip with Thermal-D technology, and circuit changed to match the 4th GEN MEMS chip.
 - ◆ PFLOW2008E: Update the I²C command protocol. The sensor can communicate with the PFLOW2008P using the I²C protocol.
 - ◆ PFLOW2008E: Revised the temperature coefficient to 0.08%/°C;
- All models: Revised the repeatability to (0.5+0.15FS)%.

Revision VC.1.03 (July 2024)

- Minor corrections.

Revision VC.1.02 (December 2023)

- Corrected the I²C interface read/write sequences.

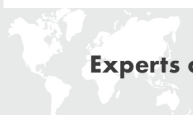
Revision VC.1.01 (November 2023)

- Update contact address.

Revision VC.1 (April 2023)

- Added the cable color.

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Revision VC.o.02 (September 2022)

- Minor correction.

Revision VC.o.01 (July 2022)

- Update service/sales and contact information.

Revision VC.o (July 2021)

- The new format and additions combine PFLOW2008, PFLOW2008N, and PFLOW2008E user manuals.

PFLOW2008 Revision VB.1 (October 2020)	PFLOW2008E Revision VB.o (November 2018)	PFLOW2008N Revision VB.o (November 2017)
➤ Revised ISO 45001.	➤ Formulated a standalone manual. ➤ Maximum pressure update.	➤ PFLOW2008N user manual first release.
PFLOW2008 Revision VB.o (November 2018)		
➤ Formulated a standalone manual.		

PFLOW2008 Revision VA.11 (August 2018)

- I²C protocol descriptions; lifetime update.

PFLOW2008 Revision VA.10 (March 2018)

- Add maximum overflow rate and flow changes.

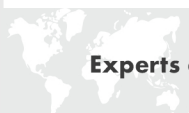
PFLOW2008 Revision VA.9 (April 2017)

- Added accuracy notes, cable connector information, installation screw torque, and revision history.

PFLOW2008 Revision VA.8 (January 2017)

- Connector information added.

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